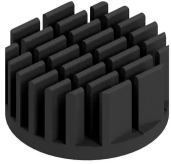


Data sheet Product ICK LED R 33 x 16,5 G



Heatsinks and active heatsinks for processors>Heatsinks for LEDs
 Ø 33 x 16,5 mm, for IC design LED

Features

diameter:	33 mm
way of fixation:	<ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive
height:	16.5 mm
plate thickness:	3.5 mm
thermal resistance:	14.3 - 3.2 K/W
dissipation loss:	8.3 W
surface:	black anodised

Technical Drawing

